

Table 1. Demographic characteristics of the study population	
Age (years)	50.0 ± 10.0
Gender	
Male	100 (100%)
Female	0 (0%)
Marital status	
Married	100 (100%)
Single	0 (0%)
Divorced	0 (0%)
Widowed	0 (0%)
Education level	
High school or less	100 (100%)
College or more	0 (0%)
Occupation	
Unemployed	100 (100%)
Employed	0 (0%)
Retired	0 (0%)
Other	0 (0%)
Religion	
Islam	100 (100%)
Christianity	0 (0%)
Judaism	0 (0%)
Hinduism	0 (0%)
Buddhism	0 (0%)
Sikhism	0 (0%)
Other	0 (0%)
Language	
Arabic	100 (100%)
English	0 (0%)
French	0 (0%)
German	0 (0%)
Italian	0 (0%)
Japanese	0 (0%)
Korean	0 (0%)
Portuguese	0 (0%)
Russian	0 (0%)
Spanish	0 (0%)
Tamil	0 (0%)
Urdu	0 (0%)
Vietnamese	0 (0%)
Other	0 (0%)
Country of origin	
Iran	100 (100%)
Afghanistan	0 (0%)
Algeria	0 (0%)
Argentina	0 (0%)
Australia	0 (0%)
Austria	0 (0%)
Bangladesh	0 (0%)
Belgium	0 (0%)
Brazil	0 (0%)
Bulgaria	0 (0%)
Canada	0 (0%)
China	0 (0%)
Czech Republic	0 (0%)
Denmark	0 (0%)
Egypt	0 (0%)
France	0 (0%)
Germany	0 (0%)
Greece	0 (0%)
Hong Kong	0 (0%)
India	0 (0%)
Indonesia	0 (0%)
Italy	0 (0%)
Japan	0 (0%)
Korea	0 (0%)
Lebanon	0 (0%)
Malaysia	0 (0%)
Mexico	0 (0%)
Netherlands	0 (0%)
New Zealand	0 (0%)
Norway	0 (0%)
Poland	0 (0%)
Portugal	0 (0%)
Romania	0 (0%)
Russia	0 (0%)
Saudi Arabia	0 (0%)
South Africa	0 (0%)
Spain	0 (0%)
Sweden	0 (0%)
Switzerland	0 (0%)
Taiwan	0 (0%)
Tanzania	0 (0%)
Thailand	0 (0%)
Turkey	0 (0%)
Ukraine	0 (0%)
United Kingdom	0 (0%)
United States	0 (0%)
Vietnam	0 (0%)
Yemen	0 (0%)
Other	0 (0%)

Embedded flush circuitry features are provided by providing a carrier foil having an electrically conductive layer therein and coating the electrically conductive layer with a dielectric material. Circuitry features are formed in the dielectric material and conductive metal is plated to fill the circuitry features.